

# 201027917 EFR32MG12 Package Type BGA125 Revision C

PRCN Issue Date: 10/27/2020 Effective Date: 2/2/2021

PCN Type: Product Revision

#### **Description of Change**

Silicon Labs is pleased to announce hardware revision C for the EFR32MG12 Package Type BGA125 devices. The new revision is a pin-compatible replacement for the previous revision B devices.

Note: After the effective date of the PRCN, Silicon Labs reserves the right not to accept orders for the old revision.

### Reason for Change

IC revision to fix errata.

### Impact on Form, Fit, Function, Quality, Reliability

The new revision is a pin compatible replacement for the previous revision B devices. There have been no changes to device pin-out (fit), quality or reliability.

#### **Product Identification**

Existing Part #	Replacement Part #	DropInCompInd.
EFR32MG12P332F1024GL125-B	EFR32MG12P332F1024GL125-C	Yes
EFR32MG12P332F1024GL125-BR	EFR32MG12P332F1024GL125-CR	Yes
EFR32MG12P432F1024GL125-B	EFR32MG12P432F1024GL125-C	Yes
EFR32MG12P432F1024GL125-BR	EFR32MG12P432F1024GL125-CR	Yes
EFR32MG12P433F1024GL125-B	EFR32MG12P433F1024GL125-C	Yes
EFR32MG12P433F1024GL125-BR	EFR32MG12P433F1024GL125-CR	Yes

#### Kit Identification

Kits impacted by the above product are listed below.

Orders for the following obsolete kits will no longer be accepted.

#### Last Date of Unchanged Product: 2/2/2021

#### **Qualification Samples**

Samples available upon request.

## **Customer Response**

Lack of acknowledgment of the PCN within 30 days constitutes acceptance of the change, Ref. JEDEC-J-STD-046.

To request further data or inquire about this notification, please contact your Silicon Labs sales representative. A list of Silicon Labs sales representatives is available at <a href="http://www.silabs.com">http://www.silabs.com</a>.

Customers may approve early PCN acceptance by emailing approval, along with PCN # to PCNEarlyAcceptance@silabs.com

## **User Registration**

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#### **Qualification Data**

Please see attached Qualification Report in the Appendix.

## EFR32xG12 Qualification Report

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			Lot ID or	Fail/Pass or			
Test Name	Test Condition	Qualification	Start	End	Notes	Summary	Status
	Accelerated Environment Stress	s Tests - BGA					
HAST	JA110		QO39924	0/28	1		
	110°C, 85%RH	3 lots, N=>25	Q039925	0/28	1	3 lots	Pass
	Vcc=3.8V, 264 hours		QO39926	0/28	1	0/84	
JHAST	JA118		Q039915	0/28	1		
	130°C, 85%RH	3 lots, N=>25	Q039916	0/28	1	3 lots	Pass
	96 hours		Q039917	0/28	1	0/84	
emp Cycle	JA104		Q039918	0/27	1		
	Cond C: -65°C to 150°C	3 lots, N=>25	Q039919	0/28	1	3 lots	Pass
	500 cycles		Q039920	0/28	1	0/83	
HTSL	JA103		Q039921	0/27	1		
	150°C, 1000hr	3 lots, N=>25	Q039922	0/28	1	3 lots	Pass
			Q039923	0/28	1	0/83	
	Accelerated Environment Stres	s Tests - QFN					
HAST			Q039879	1/30	2, 5		
	JA110	3 lots, N=>25	Q040220	0/30	2	4 lots	Pass
	130°C, 85%RH		Q039877	0/30	2		
	Vcc=3.8V, 96 hours		Q039878	0/30	2	1/120	
JHAST	JA118		Q039876	0/30	2		
	130°C, 85%RH	3 lots, N=>25	Q039875	0/30	2	3 lots	Pass
	96 hours		Q039874	0/30	2	0/90	
emp Cycle	JA104		Q039882	0/30	2		
	Cond C: -65°C to 150°C	3 lots, N=>25	Q039881	0/30	2	3 lots	Pass
	500 cycles		Q039880	0/30	2	0/90	
HTSL	JA103		Q038038	0/28	2		
	150°C, 1000hr	3 lots, N=>25	Q038124	0/28	2	3 lots	Pass
			Q037590	0/25	2	0/81	

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Part Rev C, TSMC Fabrication, SPIL Assembly except as noted   Lot ID or Fail/Pass or							
Test Name	Test Condition	Qualification	Start	End	Notes	Summary	Status
Test Group B – Acc	celerated Lifetime Simulation	n Tests					
HTOL	JA108		Q039946	0/77			
	T <sub>J</sub> ≥ 125°C, Dynamic	3 lots, N=>77	Q040071	0/77		3 lots	Pass
	Vcc=3.8V, 1000 hours		Q040505	0/80		0/234	
LTOL	JA108						
	T <sub>A</sub> = -10°C, Dynamic	1 lot, N=>32	Q040261	0/35		1 lots	Pass
	Vcc=3.8V, 1000 hours					0/35	
ELFR	JA108		Q039943	0/500			
	T <sub>J</sub> ≥ 125°C, Dynamic	3 lots, N=>500	Q040035	0/502		3 lots	Pass
	Vcc=3.8V, 48 hours		Q040504	0/500		0/1502	
NVM Endurance,	JESD22-A117		Q040213	0/40	3		
Retention and	25°C	3 lots, N=>39	Q040274	0/40	3	3 lots	
Operating Life	500 hours		Q040278	0/40	3	0/120	Pass
NVM Endurance,	JESD22-A117		Q040279	0/40	4		
Retention and	125°C	3 lots, N=>39	Q040275	0/40	4	3 lots	
Operating Life	1000 hours		Q040214	0/40	4	0/120	Pass
Test Group E – Ele	ctrical Verification						
ESD-HBM	JS-001						
		1 lot, N=>3	Q039756			2 kV	Class 2
ESD-CDM	JS-002		Q042050		6	500 V	Class C2A
		1 lot, N=>3	Q042047		7	650 V	Class C2A
			Q042046		8	1000 V	Class C3
			Q042048		9	500 V	Class C2A
Latch Up	JESD78						
	±100mA	1 lot, N=>3	Q039757	25 °C			Pass
Latch Up	JESD78 ±100mA	1 lot, N=>3	Q039764	125 °C			Pass

#### Notes:

- 1. Parts are Pre-conditioned at MSL3/260°C
- 2. Parts are Pre-conditioned at MSL2/260°C
- 3. Preconditioned with 10K write/erase cycles at 25°C
- Preconditioned with 10K write/erase cycles at 125°C
- Failure analysis on the failure was inconclusive. An additional 30 units were stressed from the same assembly lot (Q040220) to reduce the LTPD% below the requirement. JEDEC sample size requirement of 25 units per lot has LTPD% = 9.21 at 90% confidence with 0 fails. With larger sample size = 60, LTPD% = 6.48 at 90% confidence with 1 failure.

# EFR32xG12 Qualification Report

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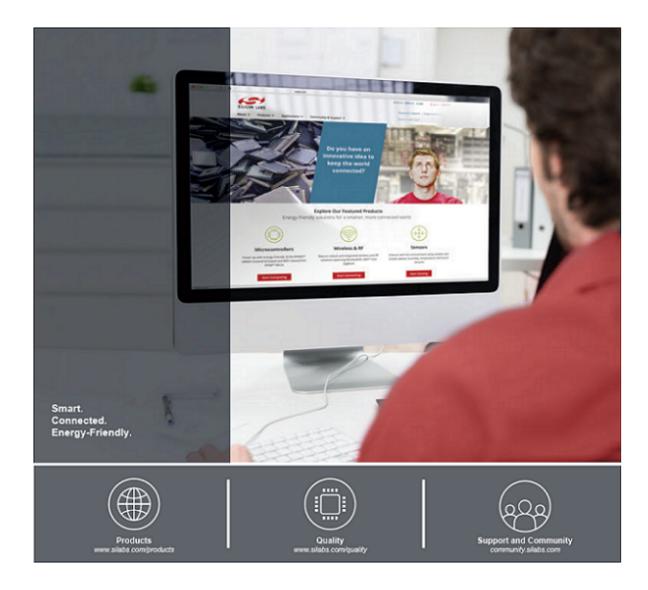
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Part Rev C, TSMC Fabrication, SPIL Assembly except as noted							
Test Name	Test Condition	Qualification	Lot ID or Start	Fail/Pass or End		Summary	Status

Notes (Continued):

- 6. BGA Package, dual band
- 7. QFN package, dual band
- 8. QFN Package, sub GHz
- 9. QFN Package, 2.4 GHz

1	his report applies to the following part numbers	;
EFR32BG12P132F1024GL125-C	EFR32FG12P232F1024GL125-C	EFR32MG12P132F1024GL125-C
EFR32BG12P132F1024GM48-C	EFR32FG12P232F1024GM48-C	EFR32MG12P132F1024GM48-C
EFR32BG12P232F1024GL125-C	EFR32FG12P231F1024GL125-C	EFR32MG12P232F1024GL125-C
EFR32BG12P232F1024GM48-C	EFR32FG12P231F1024GM48-C	EFR32MG12P232F1024GM48-C
EFR32BG12P332F1024GL125-C	EFR32FG12P433F1024GL125-C	EFR32MG12P332F1024GL125-C
EFR32BG12P332F1024GM48-C	EFR32FG12P433F1024GM48-C	EFR32MG12P332F1024GM48-C
EFR32BG12P433F1024GL125-C	EFR32FG12P432F1024GL125-C	EFR32MG12P433F1024GL125-C
EFR32BG12P433F1024GM48-C	EFR32FG12P432F1024GM48-C	EFR32MG12P433F1024GM48-C
EFR32BG12P432F1024GL125-C	EFR32FG12P431F1024GL125-C	EFR32MG12P432F1024GL125-C
EFR32BG12P432F1024GM48-C	EFR32FG12P431F1024GM48-C	EFR32MG12P432F1024GM48-C
EFR32BG12P332F1024IM48-C	EFR32FG12P431F1024IM48-C	EFR32MG12P332F1024IM48-C
EFR32MG12P433F1024IL125-C	EFR32MG12P433F1024IM48-C	EFR32MG12P432F1024IM48-C



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Silicon Laboratories Inc. 400 West Cesar Chavez Austin, TX 78701